



SPN30T10 N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN30T10 is the N-Channel logic enhancement mode power field effect transistor which is produced using super high cell density DMOS trench technology. SPN30T10 has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

FEATURES

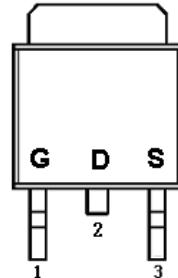
- ◆ 100V/20A,RDS(ON)=45mΩ@V_{GS}=10V
- ◆ 100V/15A,RDS(ON)=50mΩ@V_{GS}=4.5V
- ◆ High density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-252-2L/PPAK5x6-8L package design

APPLICATIONS

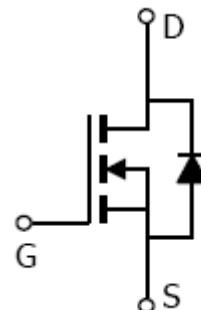
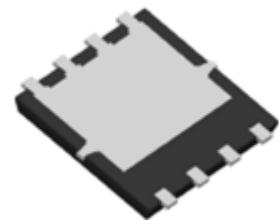
- High Frequency Small Power System
- DC/DC Converter
- Load Switch

PIN CONFIGURATION

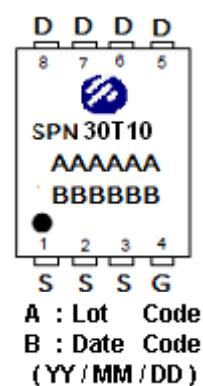
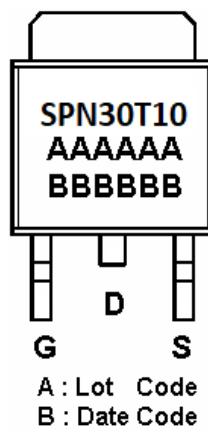
TO-252-2L



PPAK5x6-8L



PART MARKING





SPN30T10

N-Channel Enhancement Mode MOSFET

PIN DESCRIPTION (TO-252-2L)

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

PIN DESCRIPTION (PPAK5x6-8L)

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN30T10T252RGB	TO-252-2L	SPN30T10
SPN30T10DN8RGB	PPAK5x6-8L	SPN30T10

※ SPN30T10T252RGB : Tape& Reel ; Pb – Free ; Halogen – Free

※ SPN30T10DN8RGB : Tape&Reel ; Pb – Free ; Halogen - Free



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ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	100	V
Gate -Source Voltage	V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	I _D	22	A
T _C =70°C		16	
Pulsed Drain Current	I _{DM}	45	A
Avalanche Current	I _{AS}	27	A
Power Dissipation @ T _c =25°C (TO-252)	P _D	52	W
Power Dissipation@ T _c =25°C (PPAK5X6)		40	
Operating Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient (PPAK5x6)	R _{θJA}	46	°C/W
Thermal Resistance-Junction to Ambient (TO-252)	R _{θJA}	62	°C/W



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ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, ID=250uA	100			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , ID=250uA	1		2.5	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =80V, V _{GS} =0V			10	
		V _{DS} =80V, V _{GS} =0V T _J =125°C			100	uA
On-State Drain Current	I _{D(on)}	V _{DS} ≥5V, V _{GS} =10V	22			A
Drain-Source On-Resistance	R _{D(on)}	V _{GS} =10V, ID=20A			45	mΩ
		V _{GS} =4.5V, ID=15A			50	mΩ
Forward Transconductance	g _{fs}	V _{DS} =5V, ID=3A		68		S
Diode Forward Voltage	V _{SD}	I _S =1A, V _{GS} =0V			1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =15V, V _{GS} =4.5V ID= 15A		55		
Gate-Source Charge	Q _{gs}			7.5		nC
Gate-Drain Charge	Q _{gd}			7		
Input Capacitance	C _{iss}	V _{DS} =15V, V _{GS} =0V f=1MHz		3850		
Output Capacitance	C _{oss}			137		pF
Reverse Transfer Capacitance	C _{rss}			82		
Turn-On Time	t _{d(on)}	V _{DD} =50V, ID=1A, V _{GEN} =10V R _G =3.3Ω		19		
	t _r			4		
Turn-Off Time	t _{d(off)}			84		
	t _f			5		nS



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TYPICAL CHARACTERISTICS

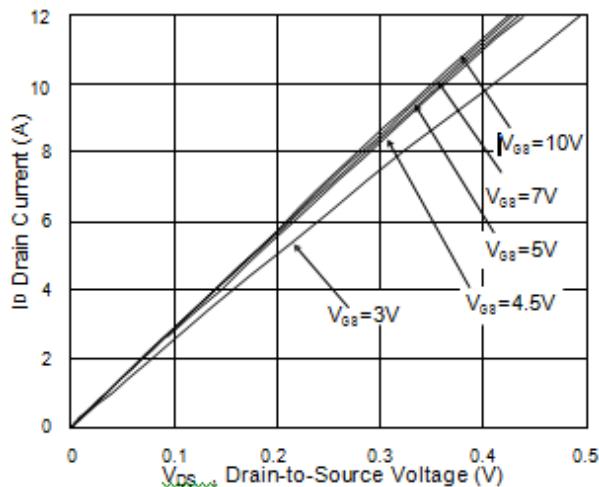


Fig. 1 Typical Output Characteristics

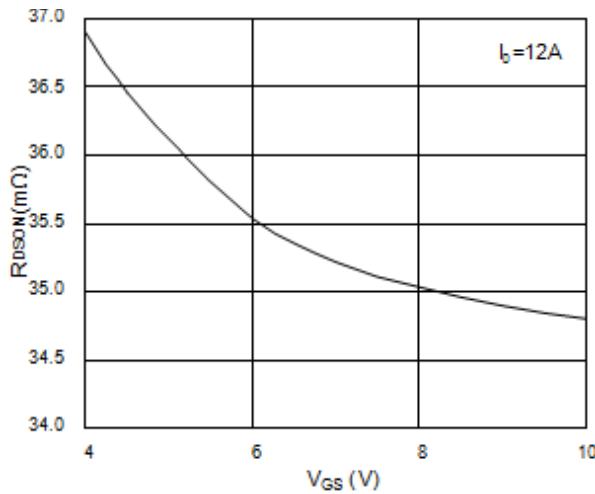


Fig. 2 On-Resistance vs. Gate Voltage

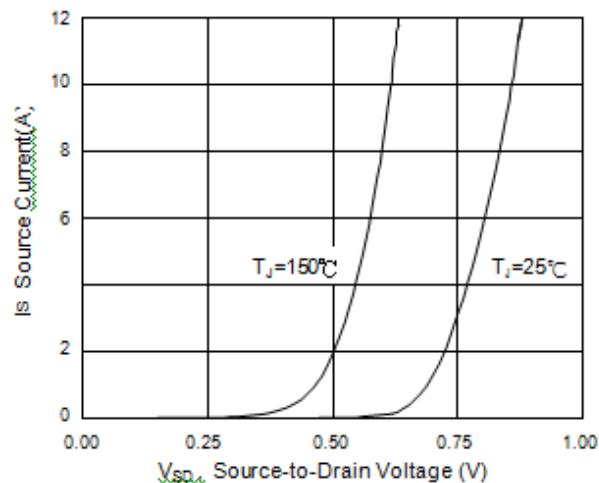


Fig. 3 Forward Characteristics of Reverse Diodes

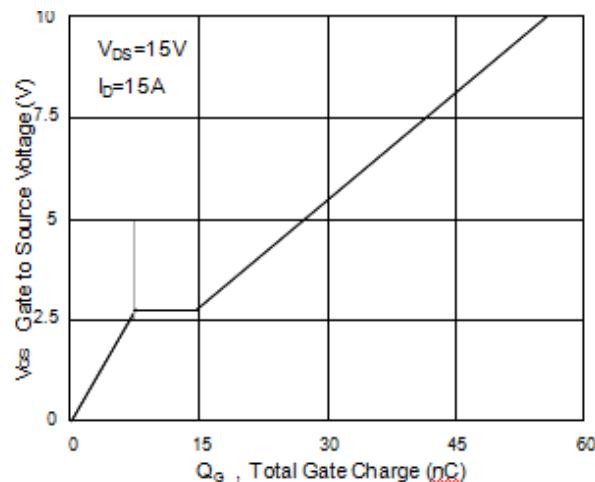


Fig. 4 Gate Charge Characteristics

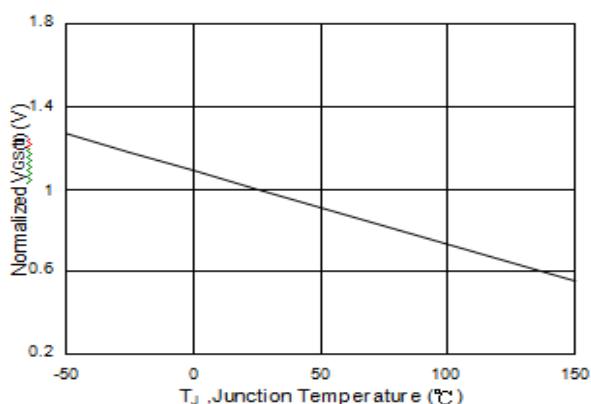


Fig. V_{GS} vs. Junction Temperature

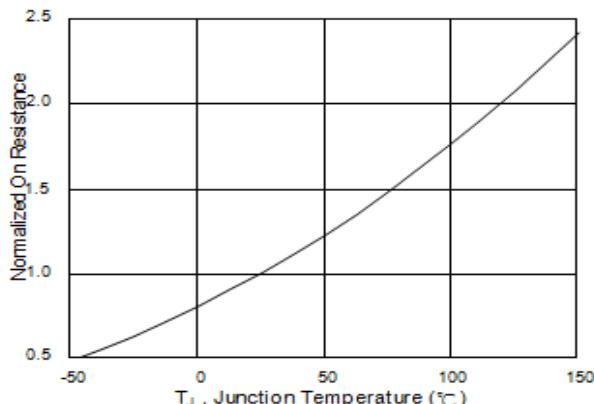


Fig. 6 On-resistance vs. Junction Temperature



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TYPICAL CHARACTERISTICS

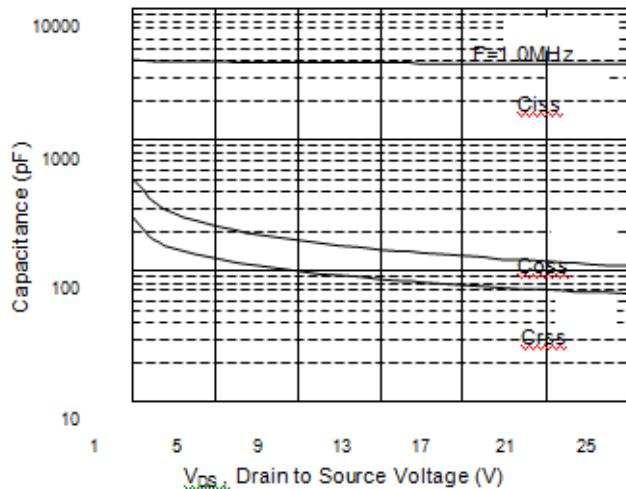


Fig. 7 Typical Capacitance Characteristics

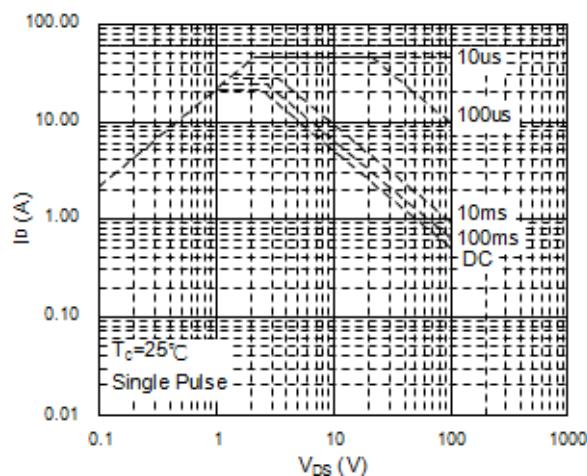


Fig. 8 Maximum Safe Operation Area

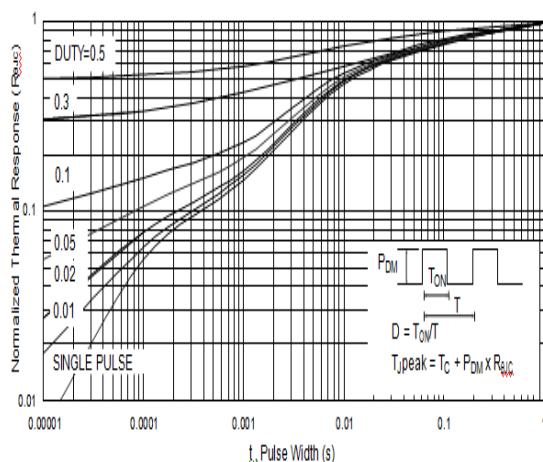


Fig. 9 Effective Transient Thermal Impedance

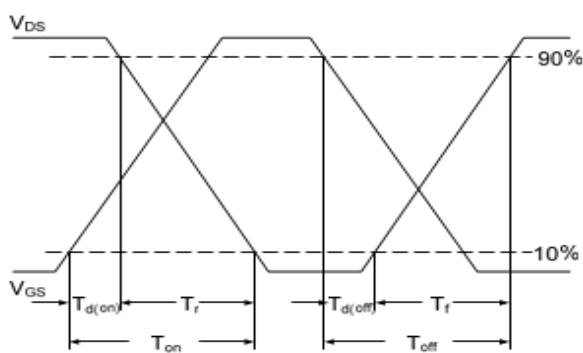


Fig. 10 Switching Time Waveform

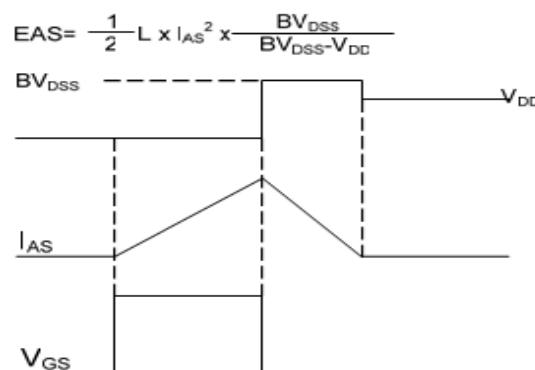


Fig. 11 Unclamped Inductive Waveform



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